DISCLOSURE AND RECORD OF INVENTION FORM

Note: When completed, the Disclosure and Record of Invention Form is an important legal document. Care should be taken in its preparation. If you desire assistance, call the Office of Technology and Industry Alliances (TIA) at 805-893-5196. Information contained in this document is maintained in confidence by TIA and normally will not be released to others except with attorney-client privilege, to research sponsors as required by contract, or under appropriate secrecy agreements, until a patent application is filed, the information is published, a determination not to file a patent application is made, or as may be required by law. The information contained should not be disclosed to others outside the University without advance notice to TIA. TIA may send your Record of Invention to other University employees for peer review.

PART A - BACKGROUND				
1. INVENTION TITLE: Provide a sh	ort descriptive title o	of the invention.		
2. DISCLOSURES OUTSIDE OF research sponsor). Please attach co			e invention to non-UC	personnel (including the
To whom was the invention disclosed?	Date of disclosure	Nature of disclosure etc.)	(oral, written, by actual	use or demonstration, sale,
Note: The public disclosure or publication of most foreign countries. U.S. patent application of the invention. Please contact TIA if you have 3. PUBLICATIONS: Identify any suinvention for publication, for present submission.	ns may only be filed we any questions. ubmissions or planne	within the twelve mo	onths after the first "en	nabling" public disclosure s or theses relating to this
Nature of submission (paper, thesis, abstract, conference presentation)	Submission date	Has the publication been accepted?	Earliest date of <u>abstract</u> publication, if applicable (on a website or printed)	Earliest date of <u>complete</u> publication (on a website or printed)

4. **SPONSORS**: Identify the funding sources used for the development of this invention. Include all outside agencies, organizations, or companies that actually provided funding to any inventor for the research that led to the conception or reduction to practice of the invention. There may be intellectual property obligations to these funding sources.

Last updated: April 2019

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Sponsor	Grant or Contract Title	Agency Award no. or ORBit Record no. (if a gift, please state)	Principal Investigator	Subcontract? (if yes, include name of prime contractor)
Please identify is	f any of the following centers or i	nstitutes were involved. (chec	k all that apply):	
	AIM (American Institute for Mar	nufacturing Integrated Photon	ics)	
	Microsoft Q Institute			
	Complex Fluid Design Consortiu	ım		
const	ATED OUTSIDE PROFESSIO ulting, non-disclosure, facility acception with their outside profession	ess, assignment or other agree		
\circ	Yes			
0	No			
Mate data	OF PROPRIETARY DATA All rial Transfer Agreements (MTAs or materials (e.g., cell line, antibouvention that were owned/provided:) that are related <u>in any way</u> to dy, plasmid, computer softwa	o this invention? If so, ple re, or chemical compound	ase identify any proprietary d) used in the development of
Material		P	rovider	
Are there any of	her university agreements related	in any way to this invention (MOUs, collaboration agr	eements, etc.)?
\circ	Yes			
\circ	No			
If yes, please des	scribe:			

PART B - TECHNICAL DESCRIPTION

	SUMMARY OF INVENTION. Please provide a brief summary, in layman's terms, which describes the essential nature of the invention and its key novel features.
2.	COMMERCIAL ADVANTAGES. Please explain the key commercial advantages of this invention. In other words, why would a company want to invest in developing a commercial product or service based on this invention?
3.	DEVELOPMENT TIMELINE.
	CONCEPTION - What date did you first conceive this invention?

TECTING Whan 1:	d von first suggessfaller ++	this invention?		
TESTING - when die	d you first successfully test	inis invention?		
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ased, including any unp	published manuscripts that p	resent or describe the	he invention.	
for the planned research	That additional plans do you h? Would you be interested			
research funding?				
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If needed, additional inventor pages can be found on the Disclosing Your Innovation page of our web site under the Invention Disclosure Form

PART C - SIGNATURES

1. UCSB INVENTORS

Complete for UCSB employees or students who made an *intellectual contribution* to the conception or reduction to practice of the invention.

Signature	Date	Signature	Date
Name		Name	
Position (faculty, staff, st	udent, post doc)	Position (faculty, sta	aff, student, post doc)
Department/ORU		Department/ORU	
Work Address		Work Address	
		T. 1. 1	
Telephone		Telephone	
Facsimile		Facsimile	
T desimile			
Email		Email	
Joint or Non-UCSB Emp	loyer, if applicable	Joint or Non-UCSB	Employer, if applicable
Home Address (required	for patent applictions):	Home Address (requ	uired for patent applictions):
			: (
Country of Citizenship (r	required for patent applications):	Country of Citizensh	nip (required for patent applications):

UCSB INVENTORS CONTINUED

Complete for UCSB employees or students who made an <u>intellectual contribution</u> to the conception or reduction to practice of the invention.

Signature Date	Signature Date
Name	Name
Position (faculty, staff, student, post doc)	Position (faculty, staff, student, post doc)
Department/ORU	Department/ORU
Work Address	Work Address
The start address	W CHATAGASS
Telephone	Telephone
retephone	reiephone
Facsimile	Facsimile
Email	Email
Ellian	Eman
Joint or Non-UCSB Employer, if applicable	Joint or Non-UCSB Employer, if applicable
Home Address (required for patent applictions):	Home Address (required for patent applictions):
Country of Citizenship (required for patent applications):	Country of Citizenship (required for patent applications):

2. INVENTORS NOT AFFILIATED WITH UCSB AT THE TIME OF INVENTION

Complete for all Non-UCSB individuals who made an <u>intellectual contribution</u> to the conception or reduction to practice of the invention who were <u>not affiliated with UCSB</u> at the time of invention. **Please note that signatures for Non-UCSB inventors are preferred, but not required.**

Signature (NON-UCSB Signature Optional Date	Signature (NON-UCSB Signature Optional Date
N.	N
Name	Name
Title	Title
Employer	Employer
Work Address	Work Address
Telephone	Telephone
Facsimile	Facsimile
Home Address (required for patent applictions):	Home Address (required for patent applictions):
Country of Citizenship (required for patent applications):	Country of Citizenship (required for patent applications):
Country of Citizenship (required for patent applications):	Country of Citizenship (required for patent applications):

The signatures of two tec understood your inventio	• 1	se UC employees when possible), w	ho have reviewed and
Signature	Date	Signature	Date

Print Name

Submit this form with ORIGINAL SIGNATURES FOR ALL UCSB AFFILIATED INVENTORS directly to:

Director Office of Technology and Industry Alliances (TIA) 342 Lagoon Rd., Mail Code 2055 University of California, Santa Barbara Santa Barbara, CA 93106-2055

Print Name

If you do not receive an acknowledgment within 30 days, please call TIA at 805-893-5196

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